503037197 10/28/2014

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
FRANCOIS HEBERT	10/28/2014
YON SUP PANG	10/28/2014
SEONG MIN CHO	10/28/2014
JU HO KIM	10/28/2014

RECEIVING PARTY DATA

Name:	MAGNACHIP SEMICONDUCTOR, LTD.	
Street Address:	215, DAESIN-RO, HEUNGDEOK-GU, CHUNGCHEONGBUK-DO, 361-725	
City:	CHEONGJU-SI	
State/Country:	KOREA, REPUBLIC OF	

PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	14525545	

CORRESPONDENCE DATA

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using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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SIGNATURE:	/S. Mahmood Ahmad/
DATE SIGNED:	10/28/2014

Total Attachments: 3

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PATENT 503037197 REEL: 034050 FRAME: 0440

Attorney Docket No.: 023103.0123

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

DECEMBER 101
As a below-named inventor, I hereby declare that this declaration is directed to the application
attached hereto, or to United States Application Number or PCT International Application Number 14/525,545 filed on October 28, 2014 (if applicable), entitled:
VERTICAL BIPOLAR JUNCTION TRANSISTOR AND
MANUFACTURING METHOD THEREOF
The above-identified application was made or authorized to be made by me.
I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.
I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.
I have reviewed and understand the contents of the above-identified application, including the claims
I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.
ASSIGNMENT
For valuable consideration, I, as a below-named assignor, hereby assign to:
MagnaChip Semiconductor, Ltd. 215, Daesin-ro, Heungdeok-gu Cheongju-si, Chungcheongbuk-do, 361-725 Republic of Korea
and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title,
and interest throughout the world in the inventions and improvements that are the subject of the
application identified in the above declaration, which is United States Application Number or PCT
International Application Number 14/525,545 filed on October 28, 2014
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-

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PATENT REEL: 034050 FRAME: 0441

Attorney Docket No.: 023103.0123

identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	François HEBERT		A
Inventor's Signature	Drawers Notaket	Date	Oct 28, 2014.
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Inventor's Legal Name	Yon Sup PANG	
Inventor's Signature	J. S. Pang Date Oct. 28, 2014	
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Attorney Docket No.: 023103.0123

Inventor's Legal Name	Seong Min CHO		
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Inventor's Legal Name	Ju Ho KIM		
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